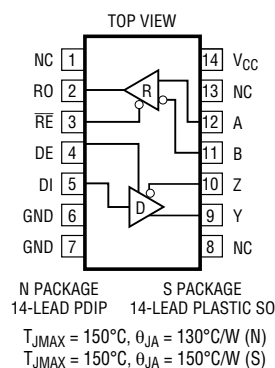
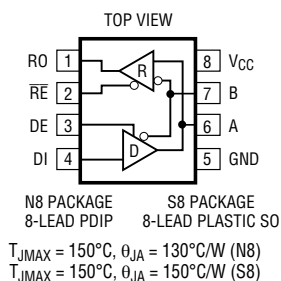


LT1785/LT1785A/ LT1791/LT1791A

ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage (V_{CC})	18V	Operating Temperature Range	
Receiver Enable Input Voltage	–0.3V to 6V	LT1785C/LT1791C/	
Driver Enable Input Voltage	–0.3V to 6V	LT1785AC/LT1791AC	0°C to 70°C
Driver Input Voltage	–0.3V to 18V	LT1785I/LT1791I/	
Receiver Input Voltage	–60V to 60V	LT1785AI/LT1791AI	–40°C to 85°C
Driver Output Voltage	–60V to 60V	LT1785H/LT1791H/	
Receiver Output Voltage	–0.3V to ($V_{CC} + 6V$)	LT1785AH/LT1791AH	–40°C to 125°C
		Storage Temperature Range	–65°C to 150°C
		Lead Temperature (Soldering, 10 sec)	300°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT1785CN8#PBF	LT1785CN8#TRPBF	1785	8-Lead PDIP	0°C to 70°C
LT1785CS8#PBF	LT1785CS8#TRPBF	1785	8-Lead Plastic SO	0°C to 70°C
LT1785IN8#PBF	LT1785IN8#TRPBF	1785I	8-Lead PDIP	–40°C to 85°C
LT1785IS8#PBF	LT1785IS8#TRPBF	1785I	8-Lead Plastic SO	–40°C to 85°C
LT1785ACN8#PBF	LT1785ACN8#TRPBF	1785A	8-Lead PDIP	0°C to 70°C
LT1785ACS8#PBF	LT1785ACS8#TRPBF	1785A	8-Lead Plastic SO	0°C to 70°C
LT1785AIN8#PBF	LT1785AIN8#TRPBF	1785AI	8-Lead PDIP	–40°C to 85°C
LT1785AIS8#PBF	LT1785AIS8#TRPBF	1785AI	8-Lead Plastic SO	–40°C to 85°C
LT1785HN8#PBF	LT1785HN8#TRPBF	1785H	8-Lead PDIP	–40°C to 125°C
LT1785HS8#PBF	LT1785HS8#TRPBF	1785H	8-Lead Plastic SO	–40°C to 125°C
LT1785AHN8#PBF	LT1785AHN8#TRPBF	1785AH	8-Lead PDIP	–40°C to 125°C
LT1785AHS8#PBF	LT1785AHS8#TRPBF	1785AH	8-Lead Plastic SO	–40°C to 125°C
LT1791CN#PBF	LT1791CN#TRPBF	1791	14-Lead PDIP	0°C to 70°C
LT1791CS#PBF	LT1791CS#TRPBF	1791	14-Lead Plastic SO	0°C to 70°C

Rev. F

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT1791IN#PBF	LT1791IN#TRPBF	1791I	14-Lead PDIP	–40°C to 85°C
LT1791IS#PBF	LT1791IS#TRPBF	1791I	14-Lead Plastic SO	–40°C to 85°C
LT1791ACN#PBF	LT1791ACN#TRPBF	1791A	14-Lead PDIP	0°C to 70°C
LT1791ACS#PBF	LT1791ACS#TRPBF	1791A	14-Lead Plastic SO	0°C to 70°C
LT1791AIN#PBF	LT1791AIN#TRPBF	1791AI	14-Lead PDIP	–40°C to 85°C
LT1791AIS#PBF	LT1791AIS#TRPBF	1791AI	14-Lead Plastic SO	–40°C to 85°C
LT1791HN#PBF	LT1791HN#TRPBF	1791H	14-Lead PDIP	–40°C to 125°C
LT1791HS#PBF	LT1791HS#TRPBF	1791H	14-Lead Plastic SO	–40°C to 125°C
LT1791AHN#PBF	LT1791AHN#TRPBF	1791AH	14-Lead PDIP	–40°C to 125°C
LT1791AHS#PBF	LT1791AHS#TRPBF	1791AH	14-Lead Plastic SO	–40°C to 125°C

AUTOMOTIVE PRODUCTS**

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT1785IS8#WPBF	LT1785IS8#WTRPBF	1785I	8-Lead Plastic SO	–40°C to 85°C
LT1785AIS8#WPBF	LT1785AIS8#WTRPBF	1785AI	8-Lead Plastic SO	–40°C to 85°C
LT1785HS8#WPBF	LT1785HS8#WTRPBF	1785H	8-Lead Plastic SO	–40°C to 125°C
LT1785AHS8#WPBF	LT1785AHS8#WTRPBF	1785AH	8-Lead Plastic SO	–40°C to 125°C

Contact the factory for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

[Tape and reel specifications](#). Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

**Versions of this part are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. These models are designated with a #W suffix. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

LT1785/LT1785A/ LT1791/LT1791A

DC ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OD1}	Differential Driver Output Voltage (Unloaded)	$I_O = 0$	●		4.1	5	V
V_{OD2}	Differential Driver Output Voltage (With Load)	$R = 50\Omega$ (RS422), Figure 1 $R = 27\Omega$ (RS485), Figure 1 $R = 18\Omega$	● ● ●	2.0 1.5 1.2	2.70 2.45 2.2		V V V
V_{OD}	Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	$R = 27\Omega$ or $R = 50\Omega$, Figure 1	●			0.2	V
V_{OC}	Driver Common Mode Output Voltage	$R = 27\Omega$ or $R = 50\Omega$, Figure 1	●	2	2.5	3	V
$\Delta V_{OC} $	Change in Magnitude of Driver Common Mode Output Voltage for Complementary Output States	$R = 27\Omega$ or $R = 50\Omega$, Figure 1	●			0.2	V
V_{IH}	Input High Voltage	DI, DE, $\overline{RE}$	●	2			V
V_{IL}	Input Low Voltage	DI, DE, $\overline{RE}$	●			0.8	V
I_{IN1}	Input Current	DI, DE, $\overline{RE}$	●			5	μA
I_{IN2}	Input Current (A, B); (LT1791 or LT1785 with DE = 0V)	$V_{IN} = 12\text{V}$ $V_{IN} = -7\text{V}$ $-60\text{V} \leq V_{IN} \leq 60\text{V}$	● ● ●	-0.15 -6	0.15 -0.08	0.3 6	mA mA mA
V_{TH}	Differential Input Threshold Voltage for Receiver	LT1785/LT1791: $-7\text{V} \leq V_{CM} \leq 12\text{V}$ LT1785A/LT1791A: $-7\text{V} \leq V_{CM} \leq 12\text{V}$	● ●	-0.2 -0.2		0.2 0	V V
ΔV_{TH}	Receiver Input Hysteresis	$-7\text{V} < V_{CM} < 12\text{V}$			20		mV
V_{OH}	Receiver Output High Voltage	$I_O = -400\mu\text{A}$, $V_{ID} = 200\text{mV}$	●	3.5	4		V
V_{OL}	Receiver Output Low Voltage	$I_O = 1.6\text{mA}$, $V_{ID} = -200\text{mV}$	●		0.3	0.5	V
	Three-State (High Impedance) Output Current at Receiver $0\text{V} < V_{OUT} < 6\text{V}$	$\overline{RE} > 2\text{V}$ or Power Off	●	-1		1	μA
R_{IN}	Receiver Input Resistance (LT1791)	$-7\text{V} \leq V_{CM} \leq 12\text{V}$ $-60\text{V} \leq V_{CM} \leq 60\text{V}$	●	85	125 125		$\text{k}\Omega$ $\text{k}\Omega$
	LT1785	$-7\text{V} \leq V_{CM} \leq 12\text{V}$	●	50	90		$\text{k}\Omega$
	RS485 Unit Load					0.25	
I_{SC}	Driver Short-Circuit Current	$V_{OUT} = \text{HIGH}$, Force $V_O = -7\text{V}$ $V_{OUT} = \text{LOW}$, Force $V_O = 12\text{V}$	● ●	35 35		250 250	mA mA
	Driver Output Fault Current	$V_O = 60\text{V}$ $V_O = -60\text{V}$	● ●	-6		6	mA mA
	Receiver Short-Circuit Current	$0\text{V} \leq V_O \leq V_{CC}$	●			± 35	mA
	Driver Three-State Output Current	$-7\text{V} \leq V_O \leq 12\text{V}$ $-60\text{V} \leq V_O \leq 60\text{V}$	● ●	-0.2 -6		0.3 6	mA mA
I_{CC}	Supply Current	No Load, $\overline{RE} = 0\text{V}$, DE = 5V No Load, $\overline{RE} = 5\text{V}$, DE = 5V No Load, $\overline{RE} = 0\text{V}$, DE = 0V No Load, $\overline{RE} = 5\text{V}$, DE = 0V	● ● ● ●		5.5 5.5 4.5 0.2	9 9 8 0.3	mA mA mA mA

SWITCHING CHARACTERISTICS

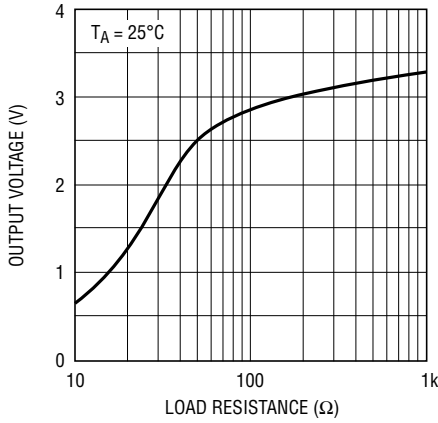
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
t_{PLH}	Driver Input to Output	Figures 3, 5	●		700	2000	ns
t_{PHL}	Driver Input to Output	Figures 3, 5	●		700	2000	ns
t_{SKEW}	Driver Output to Output	Figures 3, 5			100		ns
t_r, t_f	Driver Rise or Fall Time	Figures 3, 5	●	200	800	2000	ns
t_{ZH}	Driver Enable to Output High	Figures 4, 6	●		500	3000	ns
t_{ZL}	Driver Enable to Output Low	Figures 4, 6	●		800	3000	ns
t_{LZ}	Driver Disable Time from Low	Figures 4, 6	●		200	5000	ns
t_{HZ}	Driver Disable Time from High	Figures 4, 6	●		800	5000	ns
t_{PLH}	Receiver Input to Output	Figures 3, 7	●		400	900	ns
t_{PHL}	Receiver Input to Output	Figures 3, 7	●		400	900	ns
t_{SKD}	Differential Receiver Skew				200		ns
t_{ZL}	Receiver Enable to Output Low	Figures 2, 8	●		300	1000	ns
t_{ZH}	Receiver Enable to Output High	Figures 2, 8	●		300	1000	ns
t_{LZ}	Receiver Disable from Low	Figures 2, 8	●		400	1000	ns
t_{HZ}	Receiver Disable from High	Figures 2, 8	●		400	1000	ns
f_{MAX}	Maximum Data Rate		●	250			kbps
t_{SHDN}	Time to Shut Down	Figures 2, 6, 8			3		μs
$t_{ZH(SHDN)}$	Driver Enable from Shutdown to Output High	Figures 2, 6; $\overline{RE} = 5\text{V}$			12		μs
$t_{ZL(SHDN)}$	Driver Enable from Shutdown to Output Low	Figures 2, 6; $\overline{RE} = 5\text{V}$			12		μs
$t_{ZH(SHDN)}$	Receiver Enable from Shutdown to Output High	Figures 2, 8; $DE = 0\text{V}$			4		μs
$t_{ZL(SHDN)}$	Receiver Enable from Shutdown to Output Low	Figures 2, 8; $DE = 0\text{V}$			4		μs

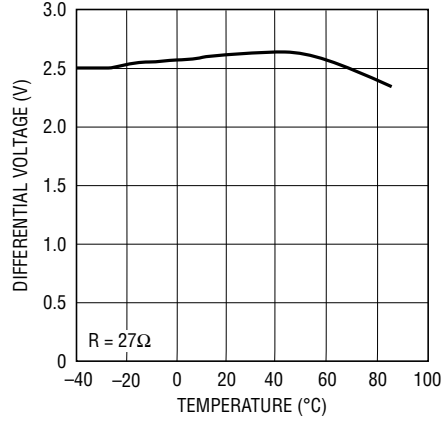
Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

TYPICAL PERFORMANCE CHARACTERISTICS

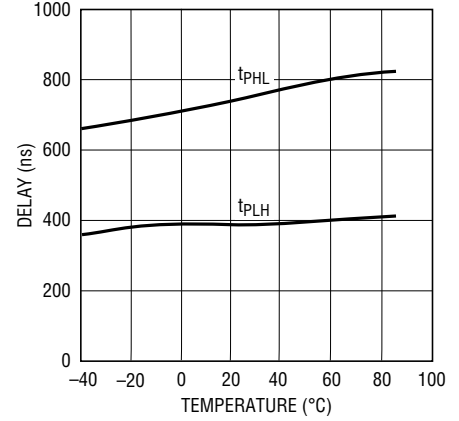
Driver Differential Output Voltage vs Load Resistance



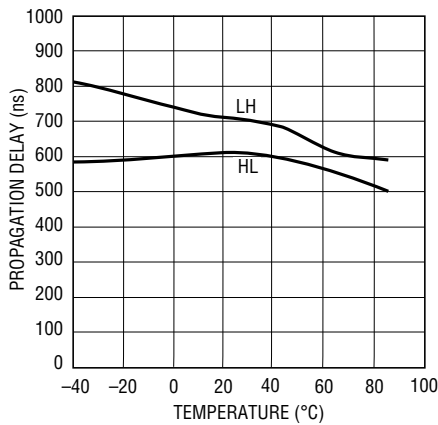
Driver Differential Output Voltage vs Temperature



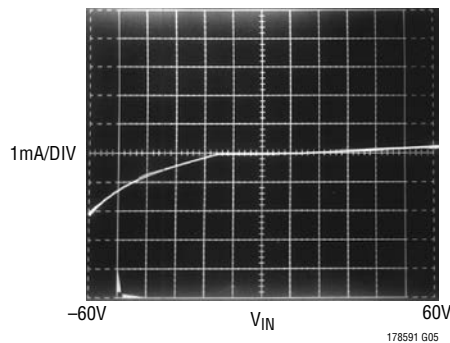
Receiver Propagation Delay vs Temperature



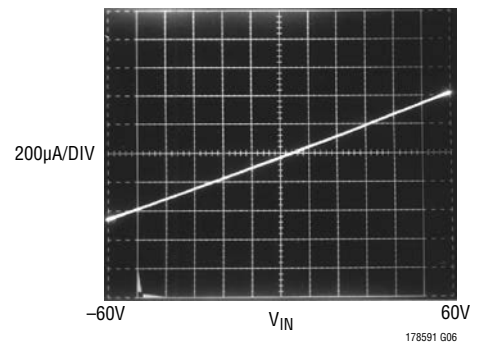
Driver Propagation Delay vs Temperature



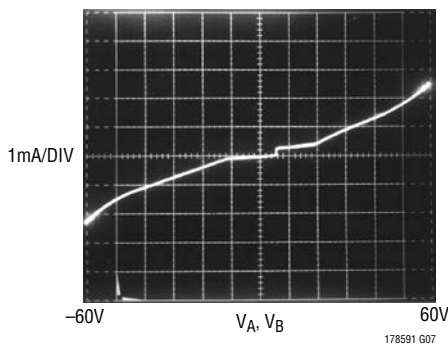
LT1791 Driver Output Leakage DE = 0V



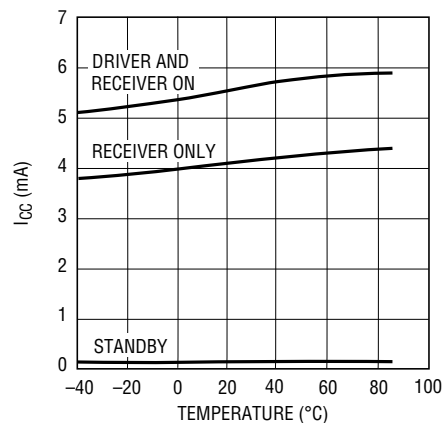
LT1791 Receiver Input Current vs VIN



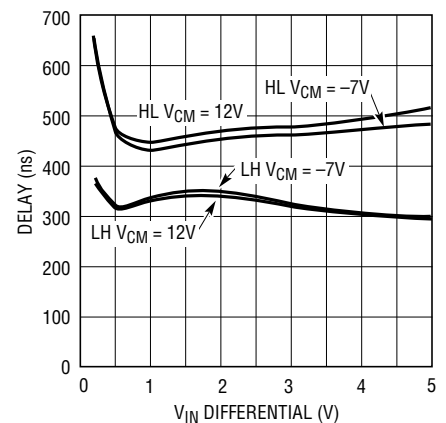
LT1785 Input Characteristics Pins A or B; DE = RE = 0V



Supply Current vs Temperature



Receiver Propagation Delay vs Differential Input Voltage



PIN FUNCTIONS

RO: Receiver Output. TTL level logic output. If the receiver is active ($\overline{RE}$ pin low), RO is high if receiver input A $\geq$ B by 200mV. If A $\leq$ B by 200mV, then RO will be low. RO assumes a high impedance output state when $\overline{RE}$ is high or the part is powered off. RO is protected from output shorts from ground to 6V.

$\overline{RE}$: Receiver Output Enable. TTL level logic input. A logic low on $\overline{RE}$ enables normal operation of the receiver output RO. A logic high level at $\overline{RE}$ places the receiver output pin RO into a high impedance state. If receiver enable $\overline{RE}$ and driver enable DE are both in the disable state, the circuit goes to a low power shutdown state. Placing either $\overline{RE}$ or DE into its active state brings the circuit out of shutdown. Shutdown state is not entered until a 3 μ s delay after both $\overline{RE}$ and DE are disabled, allowing for logic skews in toggling between transmit and receive modes of operation. For CAN bus applications, $\overline{RE}$ should be tied low to prevent the circuit from entering shutdown.

DE: Driver Output Enable. TTL level logic input. A logic high on DE enables normal operation of the driver outputs (Y and Z on LT1791, A and B on LT1785). A logic low level at DE places the driver output pins into a high impedance state. If receiver enable $\overline{RE}$ and driver enable DE are both in the disable state, the circuit goes to a low power shutdown state. Placing either $\overline{RE}$ or DE into its active state brings the circuit out of shutdown. Shutdown state is not entered until a 3 μ s delay after both $\overline{RE}$ and DE are disabled, allowing for logic skews in toggling between transmit and receive modes of operation. For CAN bus operation the DE pin is used for signal input to place the data bus in dominant or recessive states.

DI: Driver Input. TTL level logic input. A logic high at DI causes driver output A or Y to a high state, and output B or Z to a low state. Complementary output states occur for DI low. For CAN bus applications DI should be tied low.

GND: Ground.

Y: Driver Output. The Y driver output is in phase with the driver input DI. In the LT1785 driver output Y is internally connected to receiver input A. The driver output assumes a high impedance state when DE is low, power is off or thermal shutdown is activated. The driver output is protected from shorts between $\pm 60V$ in both active and high impedance modes. For CAN applications, output Y is the CANL output node.

Z: Driver Output. The Z driver output is opposite in phase to the driver input DI. In the LT1785 driver output Z is internally connected to receiver input B. The driver output assumes a high impedance state when DE is low, power is off or thermal shutdown is activated. The driver output is protected from shorts between $\pm 60V$ in both active and high impedance modes. For CAN applications, output Z is the CANH output node.

A: Receiver Input. The A receiver input forces a high receiver output when $V(A) \geq [V(B) + 200mV]$. $V(A) \leq [V(B) - 200mV]$ forces a receiver output low. Receiver inputs A and B are protected against voltage faults between $\pm 60V$. The high input impedance allows up to 128 LT1785 or LT1791 transceivers on one RS485 data bus.

The LT1785A/LT1791A have guaranteed receiver input thresholds $-200mV < V_{TH} < 0$. Receiver outputs are guaranteed to be in a high state for 0V inputs.

B: Receiver Input. The B receiver input forces a high receiver output when $V(A) \geq [V(B) + 200mV]$. When $V(A) \leq [V(B) - 200mV]$, the B receiver forces a receiver output low. Receiver inputs A and B are protected against voltage faults between $\pm 60V$. The high input impedance allows up to 128 LT1785 or LT1791 transceivers on one RS485 data bus.

The LT1785A/LT1791A have guaranteed receiver input thresholds $-200mV < V_{TH} < 0$. Receiver outputs are guaranteed to be in a high state for 0V inputs.

V_{CC}: Positive Supply Input. For RS422 or RS485 operation, $4.75V \leq V_{CC} \leq 5.25V$. Higher V_{CC} input voltages increase output drive swing. V_{CC} should be decoupled with a 0.1 μ F low ESR capacitor directly at Pin 8 (V_{CC}).

TEST CIRCUITS

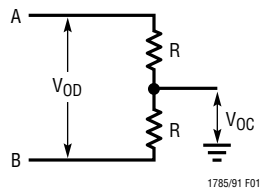


Figure 1. Driver DC Test Load

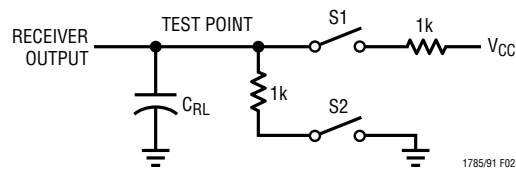


Figure 2. Receiver Timing Test Load

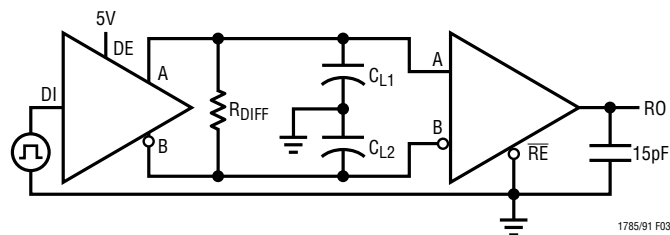


Figure 3. Driver/Receiver Timing Test Circuit

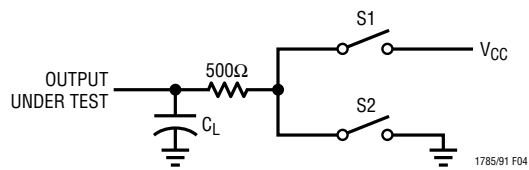


Figure 4. Driver Timing Test Load

FUNCTION TABLES

LT1785 Transmitting

INPUTS			OUTPUTS		
$\overline{RE}$	DE	DI	A	B	RO
0	1	0	0	1	0
0	1	1	1	0	1
1	0	X	Hi-Z	Hi-Z	Hi-Z
1	1	0	0	1	Hi-Z
1	1	1	1	0	Hi-Z

LT1785 Receiving

INPUTS			OUTPUT	
$\overline{RE}$	DE	DI	A-B	RO
0	0	X	$\leq -200\text{mV}$	0
0	0	X	$\geq 200\text{mV}^*$	1
0	0	X	Open	1**
1	0	X	X	Hi-Z

* $\geq 0\text{mV}$ for LT1785A

** 1 for LT1785A; 1 or 0 for LT1785

LT1791

INPUTS				OUTPUTS		
$\overline{RE}$	DE	DI	A-B	Y	Z	RO
0	0	X	$\leq -200\text{mV}$	Hi-Z	Hi-Z	0
0	0	X	$\geq 200\text{mV}^*$	Hi-Z	Hi-Z	1
0	0	X	Open	Hi-Z	Hi-Z	1**
0	1	0	$\leq -200\text{mV}$	0	1	0
0	1	0	$\geq 200\text{mV}^*$	0	1	1
0	1	0	Open	0	1	1**
0	1	1	$\leq -200\text{mV}$	1	0	0
0	1	1	$\geq 200\text{mV}^*$	1	0	1
0	1	1	Open	1	0	1**
1	0	X	X	Hi-Z	Hi-Z	Hi-Z
1	1	0	X	0	1	Hi-Z
1	1	1	X	1	0	Hi-Z

* $\geq 0\text{mV}$ for LT1791A

** 1 for LT1791A; 1 or 0 for LT1791

SWITCHING TIME WAVEFORMS

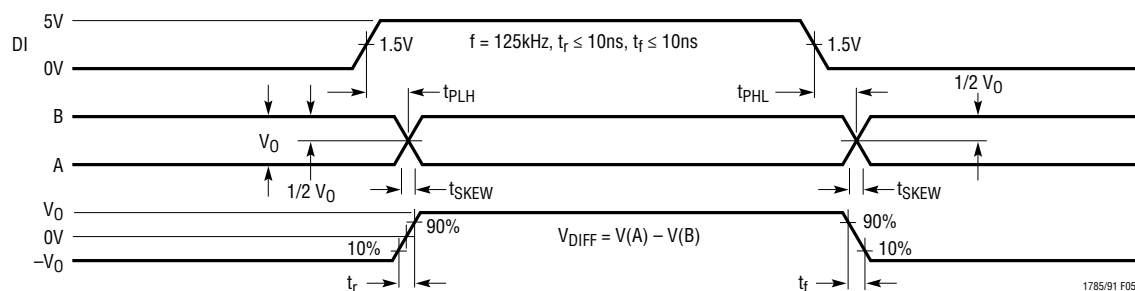


Figure 5. Driver Propagation Delays

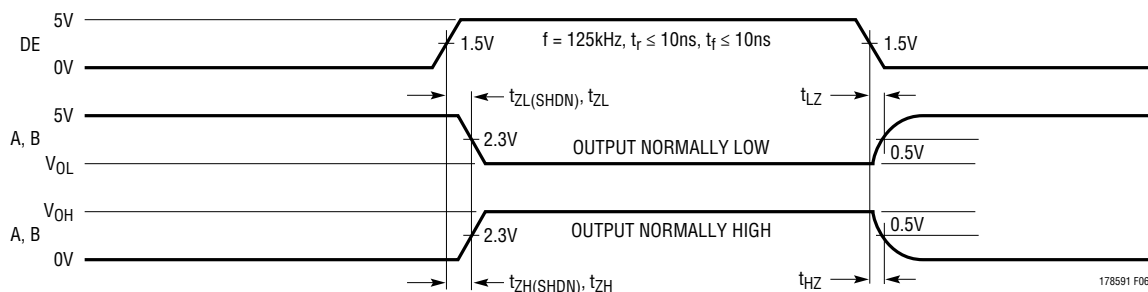


Figure 6. Driver Enable and Disable Times

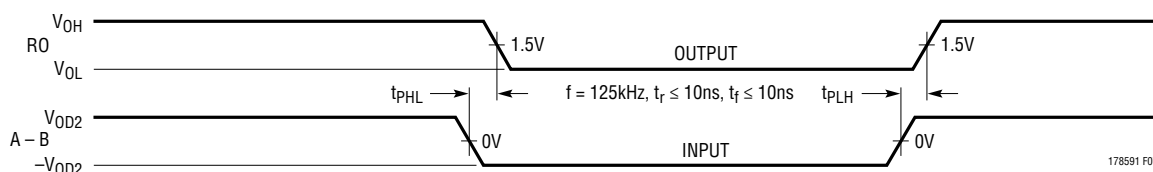


Figure 7. Receiver Propagation Delays

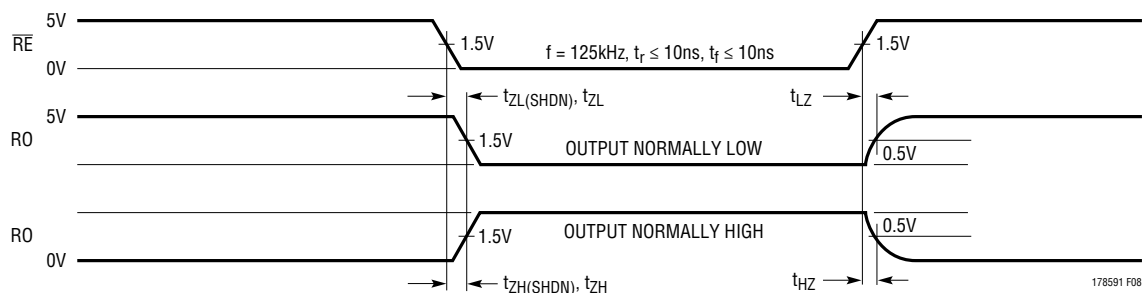


Figure 8. Receiver Enable and Disable Times

APPLICATIONS INFORMATION

Overvoltage Protection

The LT1785/LT1791 RS485/RS422 transceivers answer an applications need for overvoltage fault tolerance on data networks. Industrial installations may encounter common mode voltages between nodes far greater than the -7V to 12V range specified for compliance to RS485 standards. CMOS RS485 transceivers can be damaged by voltages above their absolute maximum ratings of typically -8V to 12.5V . Replacement of standard RS485 transceiver components with the LT1785 or LT1791 devices eliminates field failures due to overvoltage faults or the use of costly external protection devices. The limited overvoltage tolerance of CMOS RS485 transceivers makes implementation of effective external protection networks difficult without interfering with proper data network performance within the -7V to 12V region of RS485 operation.

The high overvoltage rating of the LT1785/LT1791 facilitates easy extension to almost any level. Simple discrete component networks that limit the receiver input and driver output voltages to less than $\pm 60\text{V}$ can be added to the device to extend protection to any desired level. Figure 11 shows a protection network against faults to the 120VAC line voltage.

The LT1785/LT1791 protection is achieved by using a high voltage bipolar integrated circuit process for the transceivers. The naturally high breakdown voltages of the bipolar process provides protection in powered-off and high impedance conditions. The driver outputs use a foldback current limit design to protect against overvoltage faults while still allowing high current output drive.

ESD Protection

The LT1785/LT1791 I/O pins have on-chip ESD protection circuitry to eliminate field failures caused by discharges to exposed ports and cables in application environments. The

LT1785 pins A and B and the LT1791 driver output pins Y and Z are protected to IEC-1000-4-2 level 2. These pins will survive multiple ESD strikes of $\pm 15\text{kV}$ air discharge or $\pm 4\text{kV}$ contact discharge. Due to their very high input impedance, the LT1791 receiver pins are protected to IEC-1000-4-2 level 2, or $\pm 15\text{kV}$ air and $\pm 4\text{kV}$ contact discharges. This level of ESD protection will guarantee immunity from field failures in all but the most severe ESD environments. The LT1791 receiver input ESD tolerance may be increased to IEC level 4 compliance by adding 2.2k resistors in series with these pins.

Low Power Shutdown

The LT1785/LT1791 have $\overline{\text{RE}}$ and DE logic inputs to control the receive and transmit modes of the transceivers. The $\overline{\text{RE}}$ input allows normal data reception when in the low state. The receiver output goes to a high impedance state when $\overline{\text{RE}}$ is high, allowing multiplexing the RO data line. The DE logic input performs a similar function on the driver outputs. A high state on DE activates the differential driver outputs, a low state places both driver outputs in to high impedance. Tying the $\overline{\text{RE}}$ and DE logic inputs together may be done to allow one logic signal to toggle the transceiver from receive to transmit modes. The DE input is used as the data input in CAN bus applications.

Disabling both the driver and receiver places the device into a low supply current shutdown mode. An internal time delay of $3\mu\text{s}$ minimum prevents entering shutdown due to small logic skews when a toggle between receive and transmit is desired. The recovery time from shutdown mode is typically $12\mu\text{s}$. The user must be careful to allow for this wake-up delay from shutdown mode. To allow full 250kbaud data rate transmission in CAN applications, the $\overline{\text{RE}}$ pin should be tied low to prevent entering shutdown mode.

APPLICATIONS INFORMATION

Slew Limiting for EMI Emissions Control

The LT1785/LT1791 feature controlled driver output slew rates to control high frequency EMI emissions from equipment and data cables. The slew limiting limits data rate operation to 250kbaud. Slew limiting also mitigates the adverse affects of imperfect transmission line termination caused by stubs or mismatched cable. In some low speed, short distance networks, cable termination may be eliminated completely with no adverse effect on data transmission.

Data Network Cable Selection and Termination

Long distance data networks operating at high data transmission rates should use high quality, low attenuation cable with well-matched cable terminations. Short distance networks at low data rates may use much less expensive PVC cable. These cables have characteristic impedances as low as 72Ω . The LT1785/LT1791 output drivers are guaranteed to drive cables as low as 72Ω .

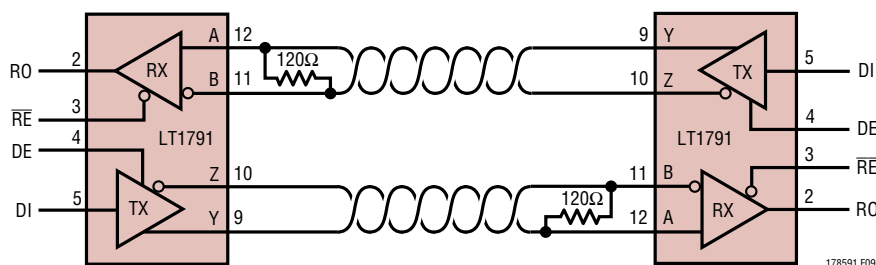
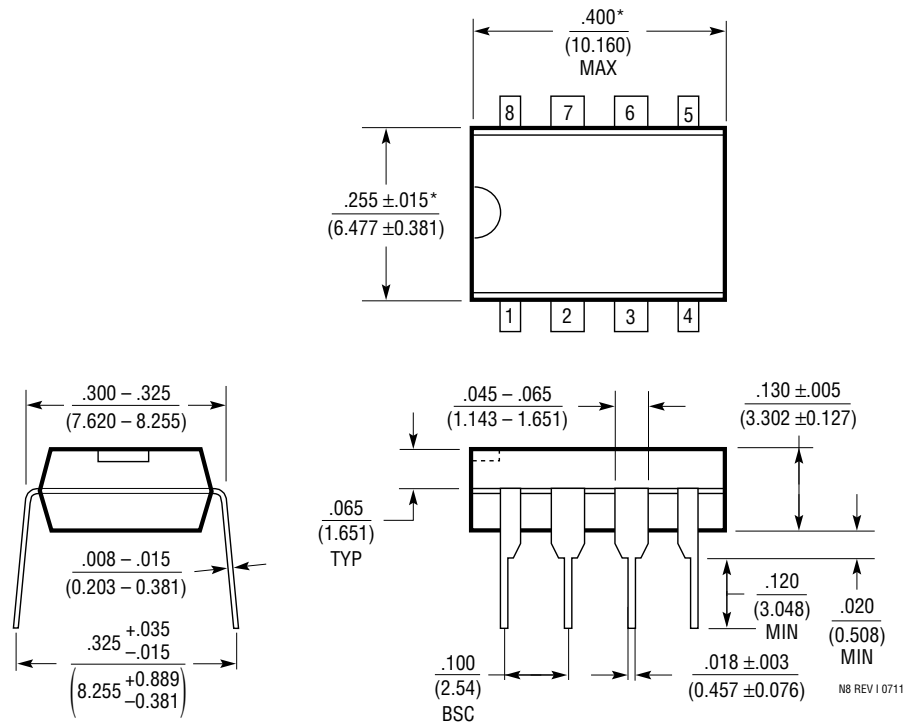


Figure 9. Full-Duplex RS422

PACKAGE DESCRIPTION

N Package
8-Lead PDIP (Narrow .300 Inch)
(Reference LTC DWG # 05-08-1510 Rev I)



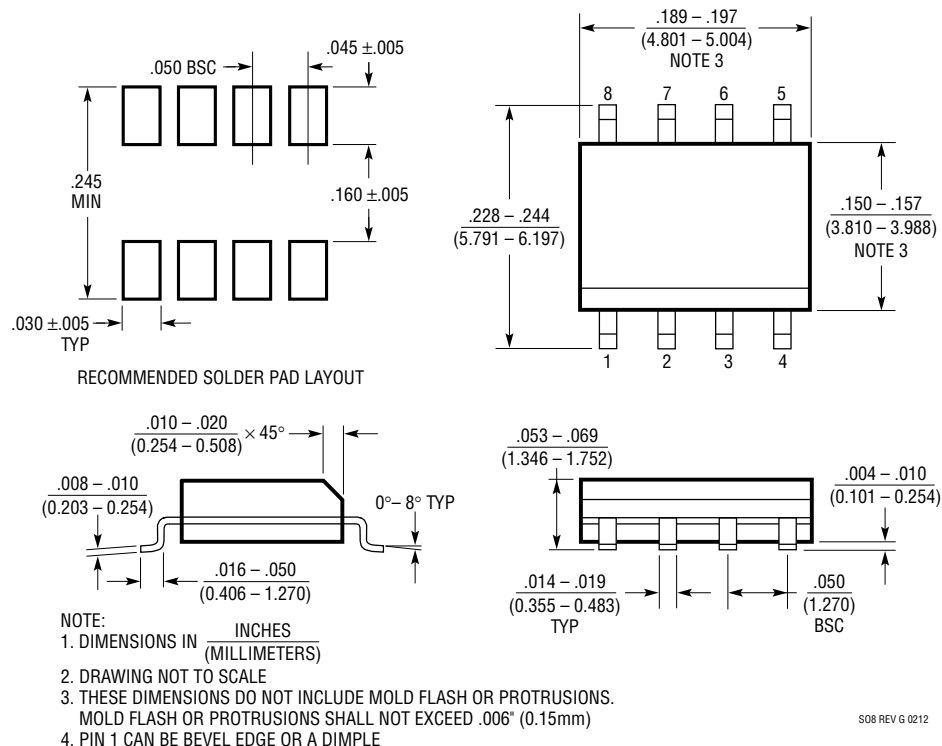
NOTE:

1. DIMENSIONS ARE INCHES
MILLIMETERS

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

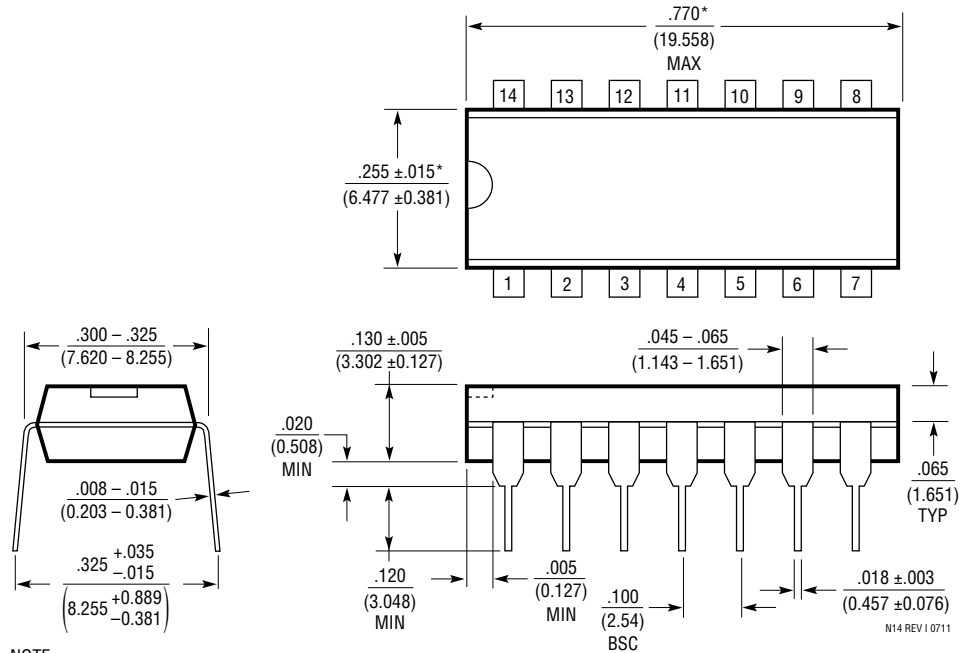
PACKAGE DESCRIPTION

S8 Package
8-Lead Plastic Small Outline (Narrow .150 Inch)
(Reference LTC DWG # 05-08-1610 Rev G)



PACKAGE DESCRIPTION

N Package
14-Lead PDIP (Narrow .300 Inch)
(Reference LTC DWG # 05-08-1510 Rev I)

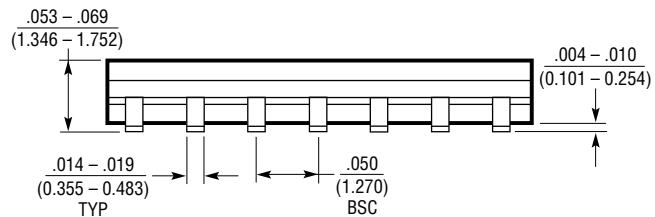
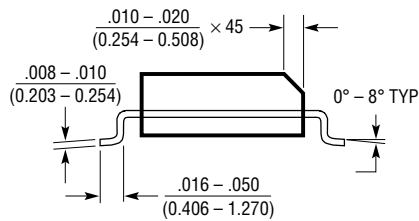
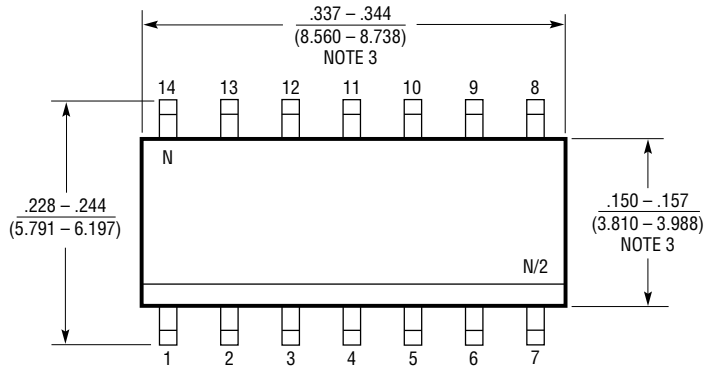
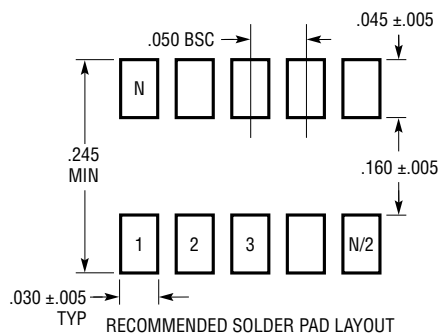


NOTE:
1. DIMENSIONS ARE $\frac{\text{INCHES}}{\text{MILLIMETERS}}$

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

PACKAGE DESCRIPTION

S Package
14-Lead Plastic Small Outline (Narrow .150 Inch)
(Reference LTC DWG # 05-08-1610 Rev G)



- NOTE:
1. DIMENSIONS IN $\frac{\text{INCHES}}{\text{MILLIMETERS}}$
 2. DRAWING NOT TO SCALE
 3. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)
 4. PIN 1 CAN BE BEVEL EDGE OR A DIMPLE

S14 REV G 0212

REVISION HISTORY (Revision history begins at Rev D)

REV	DATE	DESCRIPTION	PAGE NUMBER
D	03/15	Added notes to Function Tables	9
E	12/19	Added Auto Grade	1, 3
		Removed lead based finish part options	3
F	03/20	Added Auto Grade for H temp range	3

TYPICAL APPLICATION

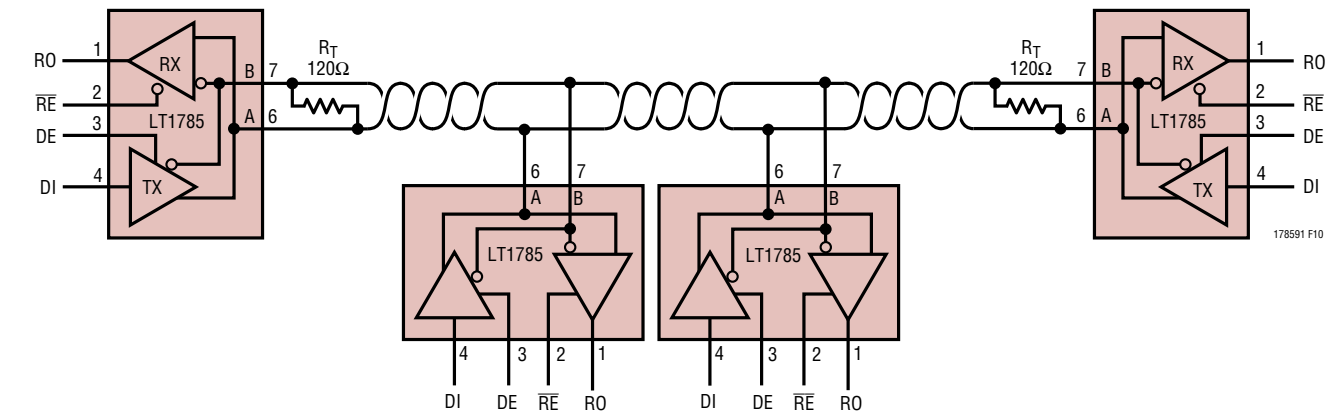


Figure 10. Half-Duplex RS485 Network Operation

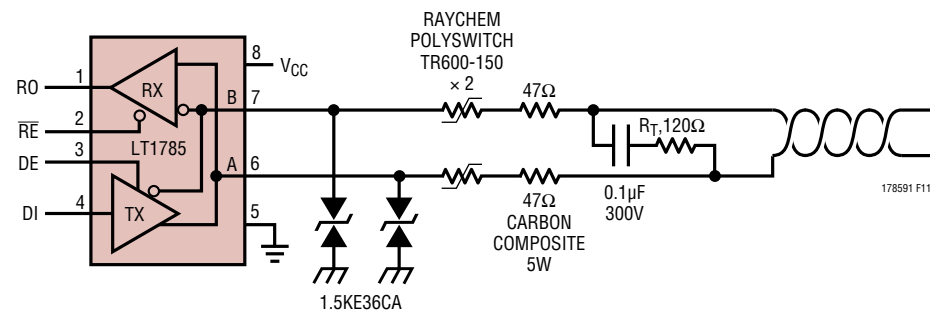


Figure 11. RS485 Network with 120V AC Line Fault Protection

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC2854/LTC2855	3.3V 20Mbps RS485/RS422 Transceivers with Integrated Switchable Termination	Up to ±25kV HBM ESD, 125°C Operation
LTC2856/LTC2857/LTC2858	5V 20Mbps and Slew Rate Limited 15kV RS485/RS422 Transceivers	±15kV ESD, 125°C Operation
LTC2850/LTC2851/LTC2852	3.3V 20Mbps RS485/RS422 Transceivers	±15kV ESD, 125°C Operation
LTC2859/LTC2861	20Mbps RS485 Transceivers with Integrated Switchable Termination	Integrated, Switchable, 120Ω Termination Resistor, ±15kV ESD
LTC2862/LTC2863/LTC2864/LTC2865	±60V Fault Protected 3V to 5.5V RS485/RS422 Transceivers	20Mbps or 250kbps, ±15kV HBM ESD, ±25V Common Mode Range
LTM2881	Complete 3.3V Isolated RS485/RS422 μModule® Transceiver + Power	2500V _{RMS} Isolation with Integrated Isolated DC/DC Converter and Switchable Termination